

Product Summary

| V_R (V) | I_F (A) | $V_{F\ MAX}$ (V) @ +25°C | $I_{R\ MAX}$ (mA) @ +25°C |
|-----------|-----------|-----------------------------|------------------------------|
| 20 | 2.0 | 0.49 | 0.16 |

Features and Benefits

- Ultra-Small Surface Mount Package
- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Description and Applications

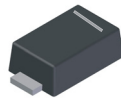
This Schottky Barrier Rectifier has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as :

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

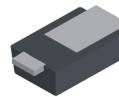
Mechanical Data

- Case: PowerDI[®]323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.006 grams (approximate)

POWERDI323



Top View



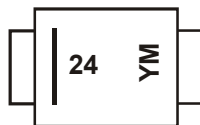
Bottom View

Ordering Information (Note 5)

| Part Number | Compliance | Case | Packaging |
|-------------|------------|--------------------------|------------------|
| PD3S220LQ-7 | Automotive | PowerDI [®] 323 | 3000/Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



24 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: B = 2014)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2014 | 2015 | 2016 | 2017 | 2018 | 2019 | 2020 |
|------|------|------|------|------|------|------|------|
| Code | B | C | D | E | F | G | H |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|--|--------------------|-------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 20 | V |
| Working Peak Reverse Voltage | V _{RWM} | | |
| DC Blocking Voltage | V _R | | |
| Average Forward Current | I _{F(AV)} | 2.0 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | 33 | A |

Thermal Characteristics

| Characteristic | Symbol | Typ | Max | Unit |
|---|-----------------------------------|-------------|-----|------|
| Thermal Resistance Junction to Soldering Point | R _{θJS} | — | 6 | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 6) | R _{θJA} | +170 | — | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 7) | R _{θJA} | +144 | — | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +125 | | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--------------------------|----------------|-----|------|------|------|--|
| Forward Voltage | V _F | — | — | 0.44 | V | I _F = 1.0A, T _A = +25°C |
| | | — | 0.42 | 0.49 | | I _F = 2.0A, T _A = +25°C |
| | | — | — | 0.36 | | I _F = 1.0A, T _A = +125°C |
| | | — | 0.35 | 0.47 | | I _F = 2.0A, T _A = +125°C |
| Leakage Current (Note 9) | I _R | — | 30 | 160 | μA | V _R = 20V, T _A = +25°C |
| | | — | 11 | 30 | | mA |
| Total Capacitance | C _T | — | 46 | — | pF | V _R = 10V, f = 1.0MHz |

- Notes:
6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 7. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 8. Short duration pulse test to minimize self-heating effect.

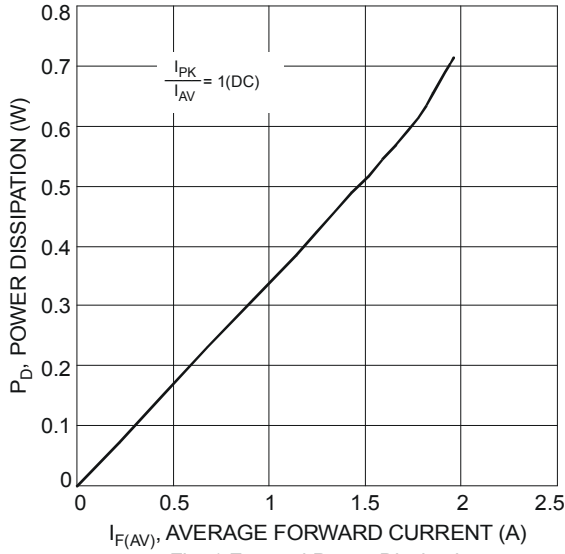


Fig. 1 Forward Power Dissipation

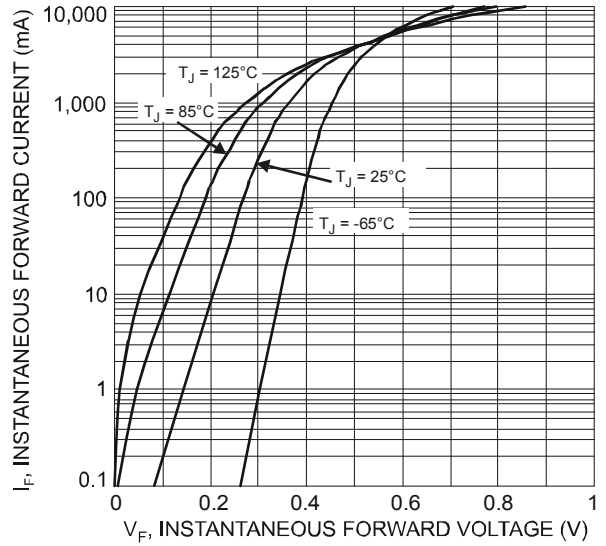


Fig. 2 Typical Forward Characteristics

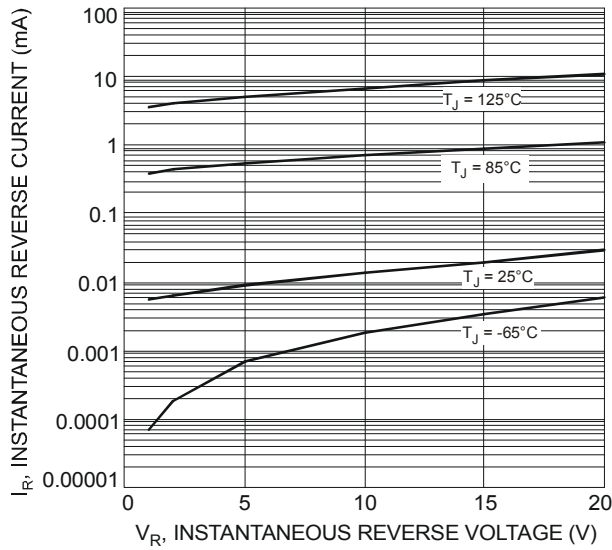


Fig. 3 Typical Reverse Characteristics

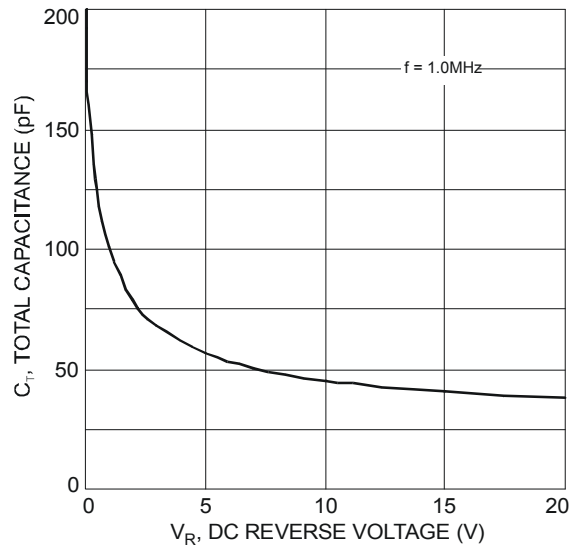


Fig. 4 Total Capacitance vs. Reverse Voltage

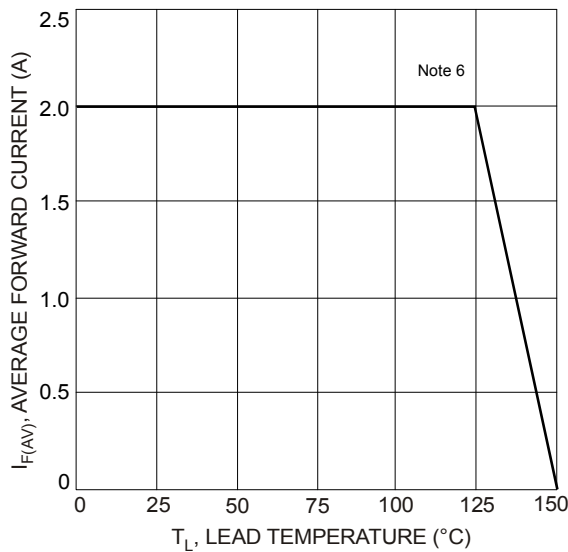


Fig. 5 Forward Current Derating Curve

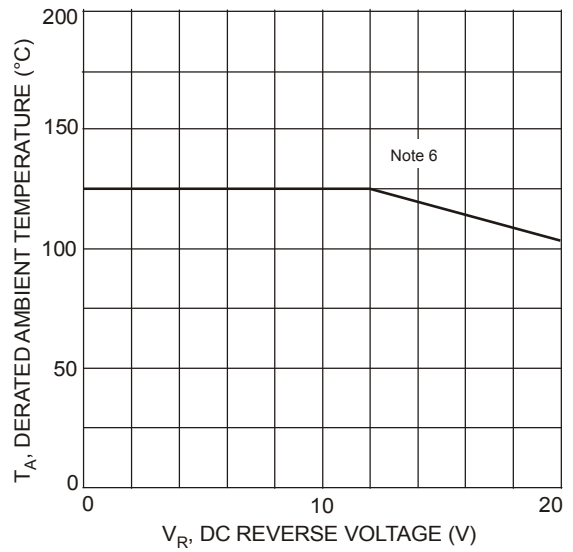
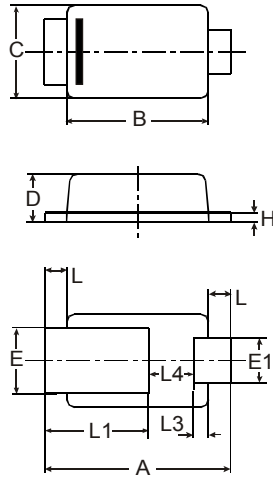


Fig. 6 Operating Temperature Derating

Package Outline Dimensions

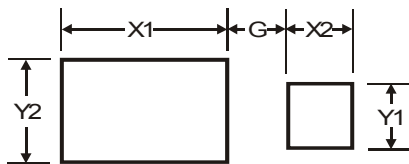
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| PowerDI [®] 323 | | | |
|--------------------------|------|------|------|
| Dim | Min | Max | Typ |
| A | 2.40 | 2.60 | 2.50 |
| B | 1.85 | 1.95 | 1.90 |
| C | 1.20 | 1.30 | 1.25 |
| D | 0.60 | 0.70 | 0.65 |
| E | 0.78 | 0.98 | 0.88 |
| E1 | 0.50 | 0.70 | 0.60 |
| H | 0.08 | 0.18 | 0.13 |
| L | 0.20 | 0.40 | 0.30 |
| L1 | — | — | 1.40 |
| L3 | — | — | 0.20 |
| L4 | 0.40 | 0.80 | 0.60 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 0.5 |
| X1 | 2.0 |
| X2 | 0.8 |
| Y1 | 0.8 |
| Y2 | 1.1 |

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2014, Diodes Incorporated

www.diodes.com